



**SLOVENSKI STANDARD**  
**oSIST prEN IEC 62496-2-5:2022**  
**01-februar-2022**

---

**Plošče z optičnimi vezji - Osnovni preskusni in merilni postopki - 2-5. del:  
Preskušanje upogljivosti za zvižava optoelektrična vezja**

Optical circuit boards - Basic test and measurement procedures - Part 2-5: Flexibility test for flexible opto-electric circuits

**iTeh STANDARD  
PREVIEW  
(standards.iteh.ai)**

**Ta slovenski standard je istoveten z: prEN IEC 62496-2-5:2021**

[oSIST prEN IEC 62496-2-5:2022](https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022)

---

<https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022>

**ICS:**

31.180	Tiskana vezja (TIV) in tiskane plošče	Printed circuits and boards
33.180.01	Sistemi z optičnimi vlakni na splošno	Fibre optic systems in general

**oSIST prEN IEC 62496-2-5:2022**

**en**

**iTeh STANDARD  
PREVIEW  
(standards.iteh.ai)**

[oSIST prEN IEC 62496-2-5:2022](https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022)

<https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022>



86/591/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

PROJECT NUMBER:  
**IEC 62496-2-5 ED1**

DATE OF CIRCULATION:  
**2021-12-17**

CLOSING DATE FOR VOTING:  
**2022-03-11**

SUPERSEDES DOCUMENTS:  
**86/570/CD, 86/582A/CC**

IEC TC 86 : FIBRE OPTICS	
SECRETARIAT: United States of America	SECRETARY: Mr Steve Swanson
OF INTEREST TO THE FOLLOWING COMMITTEES: TC 86, SC 86B, TC 91	PROPOSED HORIZONTAL STANDARD: <input type="checkbox"/> Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary.
FUNCTIONS CONCERNED: <input type="checkbox"/> EMC <input type="checkbox"/> ENVIRONMENT <input type="checkbox"/> QUALITY ASSURANCE <input type="checkbox"/> SAFETY	
<input checked="" type="checkbox"/> SUBMITTED FOR CENELEC PARALLEL VOTING	<input type="checkbox"/> NOT SUBMITTED FOR CENELEC PARALLEL VOTING
<p><b>Attention IEC-CENELEC parallel voting</b></p> <p>The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting.</p> <p>The CENELEC members are invited to vote through the CENELEC online voting system.</p>	

This document is still under study and subject to change. It should not be used for reference purposes.

Recipients of this document are invited to submit, with their comments, notification of any relevant patent rights of which they are aware and to provide supporting documentation.

TITLE:

**Optical circuit boards - Basic test and measurement procedures - Part 2-5: Flexibility test for flexible opto-electric circuits**

PROPOSED STABILITY DATE: 2026

NOTE FROM TC/SC OFFICERS:

Formerly IEC 62496-2-61. Numbering change approved by Plenary decision (see 86/577/RM, Decision 2020-03).

**Copyright © 2021 International Electrotechnical Commission, IEC.** All rights reserved. It is permitted to download this electronic file, to make a copy and to print out the content for the sole purpose of preparing National Committee positions. You may not copy or "mirror" the file or printed version of the document, or any part of it, for any other purpose without permission in writing from IEC.

## CONTENTS

1			
2			
3	FOREWORD .....		4
4	1 Scope .....		6
5	2 Normative references .....		6
6	3 Terms and definitions .....		6
7	4 Apparatus .....		7
8	4.1 General description .....		7
9	4.2 MIT tester for flexibility test of FOECBs .....		7
10	4.2.1 FOECBs test sample of fibre optical types .....		7
11	4.2.2 FOECBs test sample of planer waveguide optical circuit types .....		8
12	4.3 O-E signal control source .....		8
13	4.4 Laser source .....		8
14	4.5 Photo detector .....		8
15	4.6 Folding jig .....		9
16	4.7 Relay switch .....		9
17	4.8 Main controller .....		9
18	5 Test sample .....		9
19	5.1 FOECB test samples of optical fibre-types .....		9
20	5.2 FOECB test samples of planar optical waveguide-types .....		10
21	6 Procedures .....		11
22	6.1 For test samples of (optical fibre-types) .....		11
23	6.1.1 Preparing test samples .....		11
24	6.1.2 Initial optical and electrical performance measurement .....		12
25	6.1.3 Setting the test sample .....		12
26	6.1.4 Flexibility measurement .....		12
27	6.1.5 Final optical and electrical performance measurement .....		12
28	6.1.6 Mechanical performance measurement .....		13
29	6.2 For test samples of the planar optical waveguide-types .....		13
30	6.2.1 Preparing test samples .....		13
31	6.2.2 Initial optical and electrical performance measurement .....		13
32	6.2.3 Setting the test sample .....		13
33	6.2.4 Flexibility measurement .....		14
34	6.2.5 Final optical and electrical performance measurement .....		14
35	6.2.6 Mechanical characteristic measurement .....		14
36	7 Report .....		14
37	Annex A (informative) Detail requirement for structure of FOECB test samples of optical fibre-types .....		15
38	Annex B (normative) Requirement for structure of FOECB test samples of planar optical waveguide-types .....		16
39	Annex C (informative) Guideline for MIT folding jig setting conditions of FOECB test samples .....		17
40	Bibliography .....		18
41			
42			
43			
44			
45	Figure 1 – Schematic diagram of flexible opto-electric circuit board (top view) .....		6

46	Figure 2 – Overview of the folding jig .....	7
47	Figure 3 – Schematic diagram of the MIT test system for fibre optical circuits .....	8
48	Figure 4 – Schematic diagram of the MIT test system for planar waveguide optical circuits ....	8
49	Figure 5 – MIT folding jigs (from the left, folding radius r is 1,0 mm, 2,0 mm, 3,0 mm,	
50	4,0 mm, 5,0 mm and 10,0 mm).....	9
51	Figure 6 – Schematic diagram of FOECB test samples of optical fibre-types .....	10
52	Figure 7 – Schematic diagram of FOECB test samples of planar optical waveguide-types ....	11
53	Figure B.1 – Schematic diagram of the MIT test system for planar waveguide optical	
54	circuits .....	16
55	Figure C.1 – An example of measurement result of optical loss versus bending diameter.....	17
56		
57		
58		

**iTeh STANDARD  
PREVIEW  
(standards.iteh.ai)**

[oSIST prEN IEC 62496-2-5:2022](https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022)

<https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022>

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

---

**OPTICAL CIRCUIT BOARDS – BASIC TEST AND MEASUREMENT PROCEDURES**
**Part 2-5: Flexibility test for flexible opto-electric circuits****FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

IEC 62496-2-5 has been prepared by IEC technical committee 86: FIBRE OPTICS. It is an International Standard.

The text of this International Standard is based on the following documents:

Draft	Report on voting
86/XX/FDIS	86/XX/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at

108 [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described  
109 in greater detail at [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

110 The committee has decided that the contents of this document will remain unchanged until the  
111 stability date indicated on the IEC website under [webstore.iec.ch](http://webstore.iec.ch) in the data related to the specific  
112 document. At this date, the document will be

- 113 • reconfirmed,
- 114 • withdrawn,
- 115 • replaced by a revised edition, or
- 116 • amended.

117

## iTeh STANDARD PREVIEW (standards.iteh.ai)

[oSIST prEN IEC 62496-2-5:2022](https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022)  
[https://standards.iteh.ai/catalog/standards/sist/a994131d-  
6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-  
5-2022](https://standards.iteh.ai/catalog/standards/sist/a994131d-6c35-4fc5-9d00-8906d3ac6214/osist-pren-iec-62496-2-5-2022)

# OPTICAL CIRCUIT BOARDS – BASIC TEST AND MEASUREMENT PROCEDURES

## Part 2-5: Flexibility test for flexible opto-electric circuits

### 1 Scope

This part of IEC 62496-2 defines a test method for folding flexibility inspection of flexible opto-electric circuits with a MIT folding endurance tester and presents a guideline for a step stress test method for finding the predetermined minimum mechanical folding radii below which the flexible opto-electric circuits can be damaged by intended folding distortion. Here, test samples are used instead of products for the flexibility test of their flexible opto-electric circuits, and the test samples have the same layer structure as the products.

### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, *Environmental testing – Part 1: General and guidance*

IEC 60793-2 (all parts), *Optical fibres – Part 2: Product specifications*

IEC 62496-2-1, *Optical circuit boards – Part 2-1: Measurements – Optical attenuation and isolation*

ISO 5626:1993, *Paper – Determination of folding endurance*

### 3 Terms and definitions

For the purposes of this document, the terms and definitions defined in IEC 62496-1 and the following apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

• ISO Online browsing platform: available at <https://www.iso.org/obp>

• IEC Electropedia: available at <http://www.electropedia.org/>

#### 3.1

#### flexible opto-electric circuit board

flexible circuit board that contains both optic and electric circuits integrated into a flexible sheet

Note 1 to entry: Figure 1 shows an example of the top view of a flexible opto-electric circuit board.

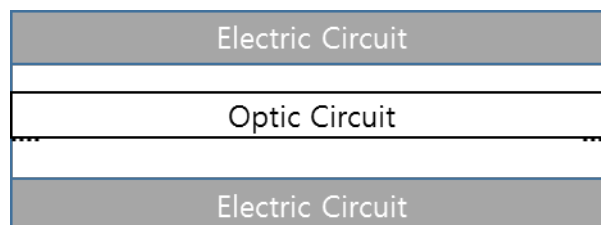


Figure 1 – Schematic diagram of flexible opto-electric circuit board (top view)



152 **3.2**153 **MIT test system**

154 instrument for folding endurance test of flexible sheets with interchangeable folding heads, allowing  
155 a range of thickness up to 1,25 mm

156 Note 1 to entry: The name of the MIT folding endurance tester follows the Massachusetts Institute of Technology because  
157 it has been developed by the institute.

158 Note 2 to entry: There are two types of flexible opto-electric circuit board: optical fibre-types and planer optical waveguide-  
159 types.

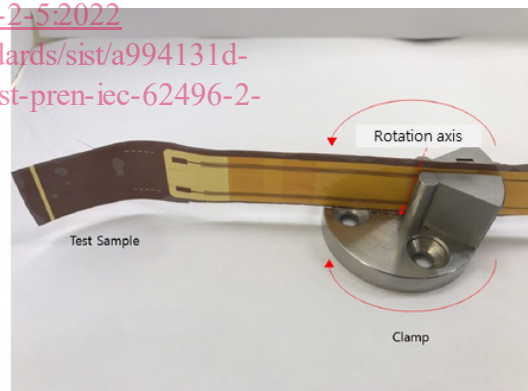
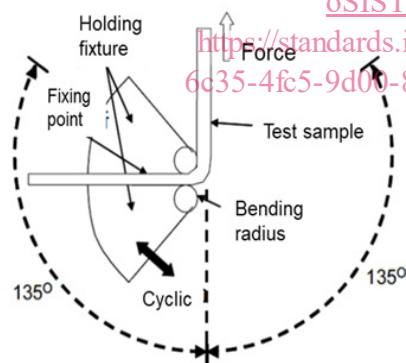
160 [SOURCE: ISO 5626:1993, Clause 1]

161 **4 Apparatus**162 **4.1 General description**

163 The MIT test system for flexibility test of the flexible opto-electric circuit board (hereafter FOECB)  
164 shall be used for finding of the minimum folding radii of both optic and electric circuits of the FOECB  
165 before any functional damage occurs. An existing MIT folding method has been used for testing  
166 the folding flexibility of only electric circuits. However, in this proposed standard, it shall be used  
167 for testing the folding flexibility of both optic and electric circuits.

168 Since the test sample for fibre optical type should be connected to the MIT test system through an  
169 optical fibre, real-time monitoring may be possible. Accordingly, the MIT tester shall be configured  
170 with a real-time monitoring system using a laser signal device to accurately know the time of  
171 breakage of the optical fibres.

172 Test samples for planar waveguide optical circuits are difficult to measure through real-time  
173 monitoring because it is not easy to connect to an MIT test device through an optical fibre.  
174 Therefore, the test sample should be tested by connecting only electric circuits as in the existing  
175 MIT folding method. The failure time of the test sample should be measured separately using a  
176 visual light on the planar waveguide circuits. In addition, these tests should be measured in the  
177 process of replacing the holding jig. The test sample shall be clamped by the folding jig within the  
178 main controller as shown in Figure 2.



179

180 a) Photograph diagram of the folding jig

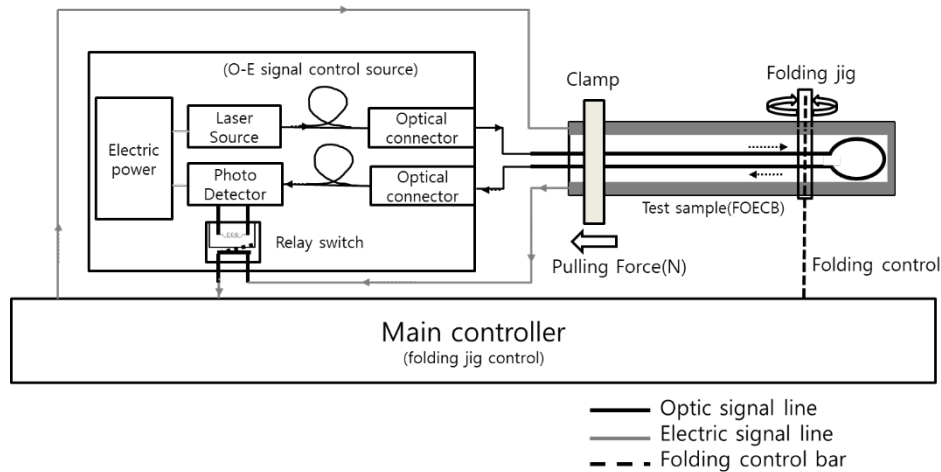
180 b) Photograph of a folding jig and test sample

181

**Figure 2 – Overview of the folding jig**

182 **4.2 MIT tester for flexibility test of FOECBs**183 **4.2.1 FOECBs test sample of fibre optical types**

184 The MIT test system for fibre optical circuits should be configured to stop the folding action of the  
185 test sample if any damage starts to appear in its optical and electrical sections. Therefore, the MIT  
186 test system shall be composed of an optic-electric signal control source (hereafter referred as O-E  
187 signal control source), test sample, and main controller, as shown in Figure 3.



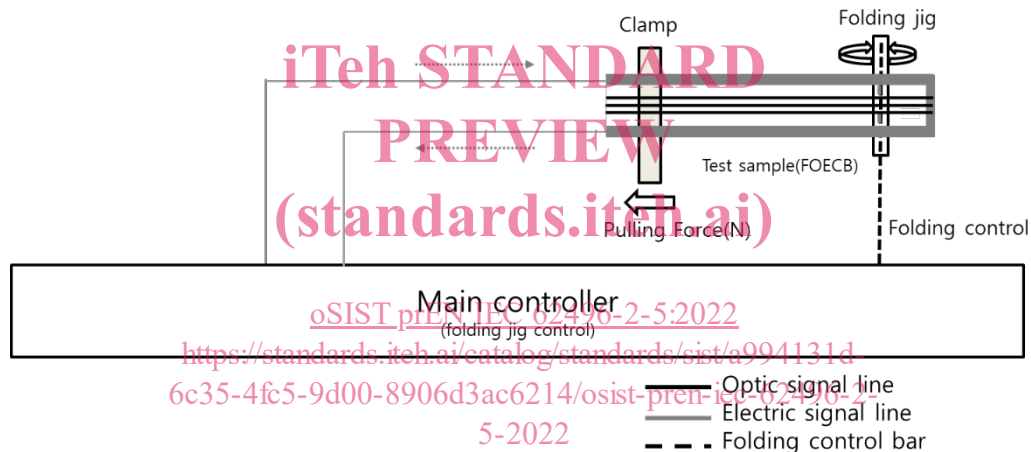
188

189

**Figure 3 – Schematic diagram of the MIT test system for fibre optical circuits**

#### 190 4.2.2 FOECBs test sample of planer waveguide optical circuit types

191 The MIT tester system for planer waveguide optical circuits shall be constructed in the same form  
 192 as the folding flexibility test method for existing electrical circuits, as shown in Figure 4.



193

**Figure 4 – Schematic diagram of the MIT test system for planer waveguide optical circuits**

#### 195 4.3 O-E signal control source

196 An O-E signal control source shall be composed of a laser source, photo detector, relay switch,  
 197 electric power source, optical fibre, and optical connectors. The O-E signal control source supplies  
 198 an optical signal to the test sample, and allows the photo detector to control the relay switch based  
 199 on detected optical signal for on-off switching of the electric signal flow (current) within the MIT test  
 200 system.

#### 201 4.4 Laser source

202 The optical output power of the laser source shall have enough larger of the minimum detected  
 203 power of optical detector and attenuation (optical loss) of samples. The laser source in the O-E  
 204 signal control source sends an optical signal to the test sample via its optical input terminal  
 205 connected to the protruded optical fibre. The wavelength and mode of the laser source should be  
 206 chosen according to the application to be used. The launching mode of the laser source should be  
 207 appropriate to the application of the relevant specification of O-E circuit board.

#### 208 4.5 Photo detector

209 The minimum detected optical power of the photo detector shall be enough to detect the optical  
 210 power after attenuating the optical power by the test sample and light source power. The photo

211 detector detects the optic signal flow in the test sample. The photo detector output controls the  
 212 relay switch inside the O-E signal control source. Therefore, the output current of the photo detector  
 213 should be above the minimum operating voltage of the relay switch with a proper resistance for the  
 214 current output. The photo detector shall have enough response frequency to detect the optical  
 215 power change (deviation) by the attenuation change caused by the folding distortion. At minimum,  
 216 the response frequency for the photo detector should be 10 times or more than the folding duration  
 217 ( $0^\circ$  to  $90^\circ$ ), or kHz order will be necessary.

#### 218 4.6 Folding jig

219 The size of the jig shall be selected according to the test samples. Several types of folding jigs with  
 220 different bending radii are required to apply various bending tests to the test sample. Folding jigs  
 221 of 6 different curvature radii (1,0 mm, 2,0 mm, 3,0 mm, 4,0 mm, 5,0 mm, and 10,0 mm) should be  
 222 prepared (see Figure 5).



223

224 **Figure 5 – MIT folding jigs (from the left, folding radius  $r$  is 1,0 mm, 2,0 mm, 3,0 mm,**  
 225 **4,0 mm, 5,0 mm and 10,0 mm)**

#### 226 4.7 Relay switch

227 The switching time shall be at least one tenth of the folding speed. The relay switch plays a role of  
 228 direct on-off switching control of the electric circuit in the MIT test system. That is, once the photo  
 229 detector detects the optic signal flow in the test sample, the relay switch stays in the on-state. If  
 230 the photo detector fails to detect the optic signal flow in the test sample, the relay switch turns to  
 231 the off-state. The relay switch operates the MIT test system depending on the detected optical  
 232 signal output at the photo detector, which is subject to the physical state of the test sample (e.g.,  
 233 either broken or non-broken state of the optic circuit).

#### 234 4.8 Main controller

235 The main controller shall control the electrical current to fold the folding jig with enough accuracy  
 236 to test. The main controller supplies an electric current to the test sample and mechanically controls  
 237 the folding action of the test sample. The main controller may consist of the main controller and the  
 238 mechanical control means of folding, separately. Generally, the main controller emits the electric  
 239 signal by itself to perform the mechanical folding operation on the test sample. The typical electric  
 240 current flowing through the main controller ranges from 1 mA to 10 mA

## 241 5 Test sample

### 242 5.1 FOECB test samples of optical fibre-types

243 Test samples of optical fibre-types shall have a pigtailed shape (see Figure 6). The optical fibres  
 244 used in the test samples may be single-mode and/or multimode fibres. Depending on applications,  
 245 glass optical fibres, polymer optical fibres, and specialty optical fibres may be used to form the  
 246 optical circuits.

247 The optical circuits shall be positioned at a central part of the entire FOECB test samples. The  
 248 electrical circuits shall be positioned at peripheral areas of the optical circuit in a symmetrical  
 249 structure. The symmetrical structure shall have superior characteristics in size stability from the  
 250 viewpoint of design and reliability for the FOECB test samples, as shown in Figure 6.

251 The test samples of the optical fibre-types shall have a protruded structure with a length of  $l_9$  at  
 252 one side. The protruded length ( $l_9$ ) shall be maintained with sufficient length over 100 mm for easy  
 253 connection with other fibres (e.g., fibre fusion splicing). The other side of the test samples shall